## AMENDMENTS TO THE SPECIFICATION

Please replace Paragraph [0079] with the following paragraph rewritten in amendment format:

**[0079]** However, when a precursor containing an amino functional group such as TEMAH is used to form the  $HfO_2$  layer, nitrogen can be included in the resulting thin film without implementing a subsequent heat treatment. For example, it has been reported that an  $HfO_2$  thin film formed using a LPCVD method using TEDAH TDEAH [ $Hf(N(C_2H_5)_2)_4$ ] and  $O_2$ , contains about 7% nitrogen.